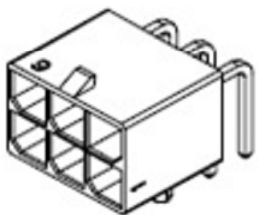


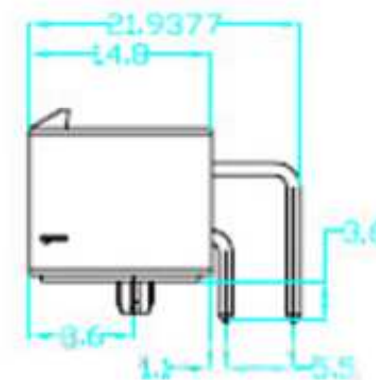
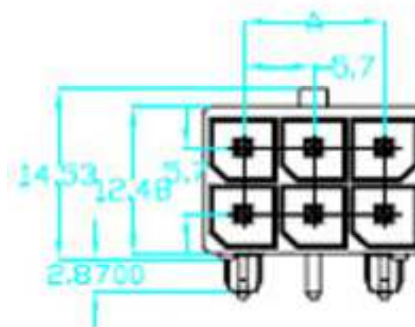
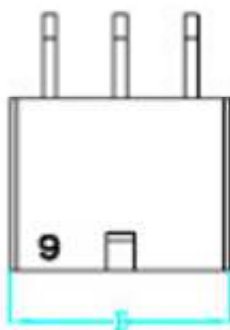
# EDCON-COMPONENTS



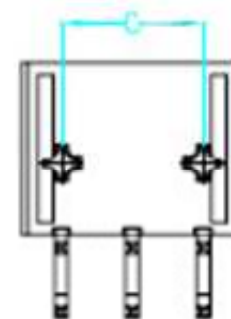
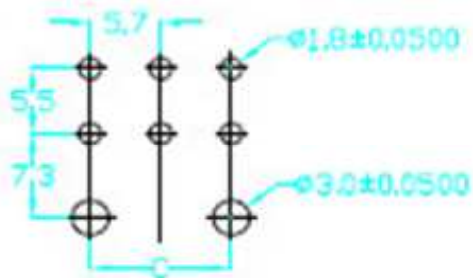
## Technical Description

Curent Rating:	23A AC/DC
Voltage Rating:	600V AC/DC
Contact Resistance:	10mΩ max.
Withstanding Voltage:	2200VAC/ DC
Insulation Resistance:	1000MΩ Min
Operating Temperature:	.-40°C to + 105°C
Contact Material:	High Conductive Copper Alloy
Contact Plating:	Matte SN over Ni
Insulator Material:	LCP + 30%G.F UL94V-0
Available Pos.	2 to 8Pos
Pin Dimension:	1,08mm Square Pin

## Drawing



## PCB Layout (mm)



Circuits	2	4	N
Dim. A	N/A	2,85x N -5,7	
Dim. B	8,34	2,85x N +0,65	
Dim. C	N/A	2,85x N -5,7	

**Wire to Board Connector  
(Wafer) Right -Angle Pin with  
Look Dual Row**

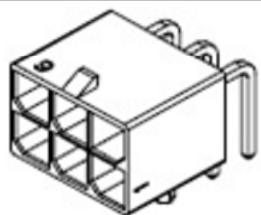
Part No.: **T68X005**

DRW:	Jason	CHKD	Wilson	Tolerance	x	x.x	x.xx	x.xxx	Angle
APPD:	Schumi				±	±0,40	±0,25	±0,15	± 3°
				MATL:	Wilson	TOLERANCE	Mason	DATE	06.06.2021
				FINISH	Jamy		Sheet No.		1 from 4

Customer:

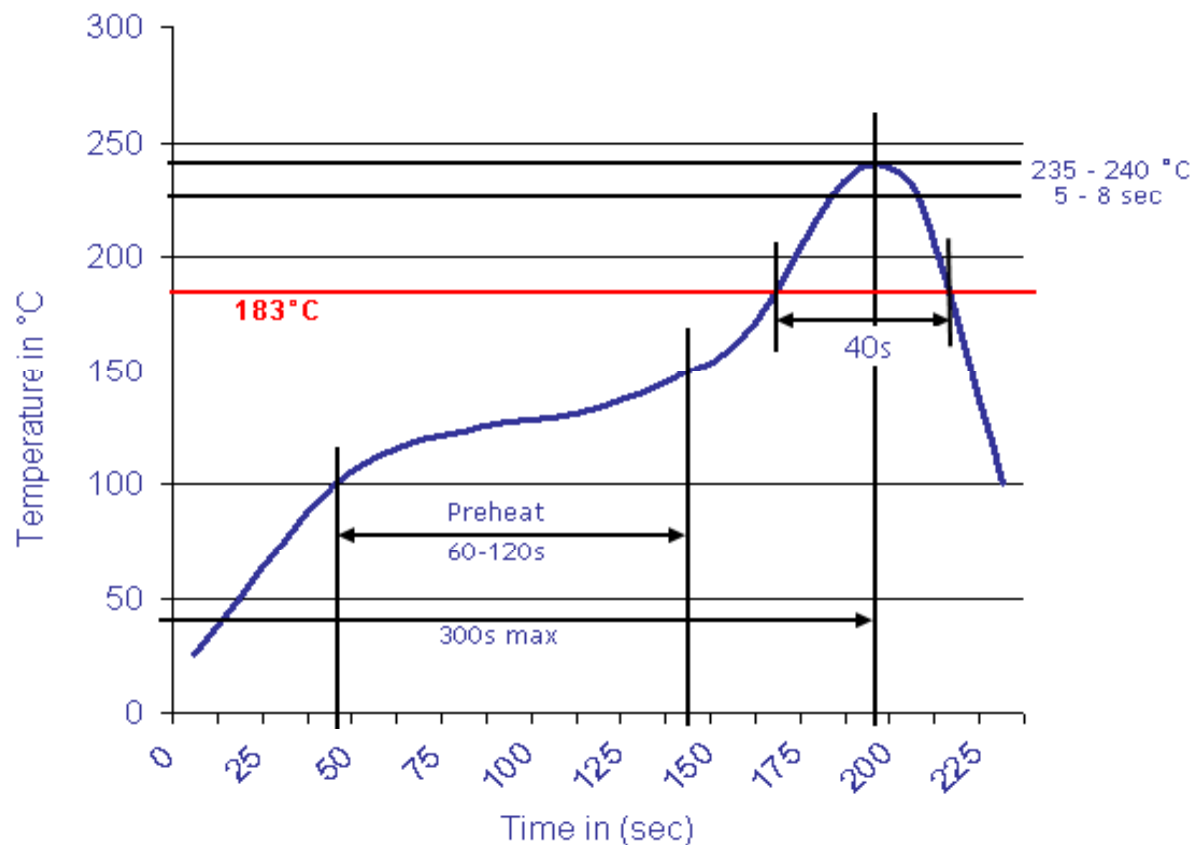






Soldering Profile Curve

Classification Reflow Profile (JEDEC J-STD-020C)



<b>Wire to Board Connector (Wafer) Right -Agle Pin with Look Dual Row</b>	
Part No.:	<b>T68X005</b>
Customer:	

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	06.06.2021
APPD:	Schumi			FINISH	Jamy		Sheet No.	4 from 4	